

Please amend Claims 1, 3 and 4 as follows:

1. (Currently Amended) A mounting structure of a wireless module, comprising:

a circuit board having electrical components including semiconductor components mounted on ~~an~~^{its} upper surface;
a cover attached to the circuit board while covering the electrical components; and

a motherboard for mounting the circuit board thereon,
wherein the cover has a box-shaped cover portion and at least one leg portion projected downward from the cover portion,

wherein at least one first through holes for inserting the at least one leg portions ~~is~~^{are} provided in the circuit board, and at least one second through holes for inserting the at least one leg portions ~~is~~^{are} provided in the motherboard, and

wherein the at least one leg portions ~~is~~^{are} soldered to the circuit board and the motherboard at the at least one first and second through holes or at ~~a~~ positions close to the at least one first and second through holes in a state wherein the at least one leg portions ~~is~~^{are} inserted into the at least one first and second through holes, respectively.

2. (Original) The mounting structure of a wireless module according to claim 1, wherein the circuit board ~~overlaps~~^{is put on} the motherboard ~~to overlap each other.~~

3. (Currently Amended) The mounting structure of a wireless module according to claim 1, wherein conductors are provided on the walls of the at least one first and second through holes, and the at least one leg portions ~~is~~^{are} soldered to the conductors.

4. (Currently Amended) The mounting structure of a wireless module according to claim 1, wherein the at least one leg portions extend in a straight-line shape.